



The **DCSG3-050560** piezoelectric stack consists of multiple chips which are bonded via epoxy. It offers a maximum displacement of  $66.0~\mu m$ . The red wire of the electrode serves as the positive terminal (+), and the black wire is the negative terminal (-).



DCSG3-050560

## **Performance Parameters**

Drive Voltage Range	-30~150 V	Capacitance	5.2μF ± 15%
Displacement (Free Stroke) at 150 V	66.0 μm ± 15%	Dissipation Factor	<2.0%
Hysteresis	<15%	Resonant Frequency	21kHZ
Stiffness	15 N/μm	Blocking Force at 150 V	1000N
Strain resistance	350Ω±0.3%	Gauge quantity	2
Curie Temperature	230 °C	Operating Temperature	-25 ~ 130 °C
Product Size	L: 5.0mm	Outer Dimensions	L: $9.0 \pm 0.2$ mm
	W: 5.0mm		$W{:}~7.0 \pm 0.2 mm$
	H: 60.0mm		H: 60.5 ± 0.1mm

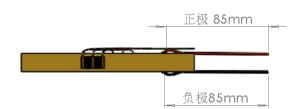
- All specifications are quoted at 25°C, unless otherwise stated.
- The displacement may vary slightly for different loads, and the maximum displacement occurs when used with the recommended load.

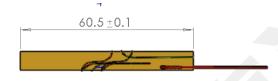
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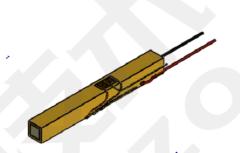


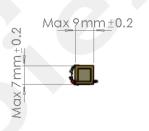


## **Product Size**

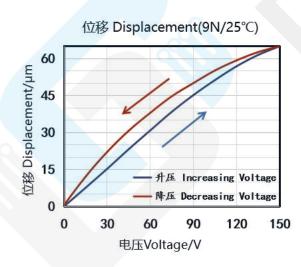


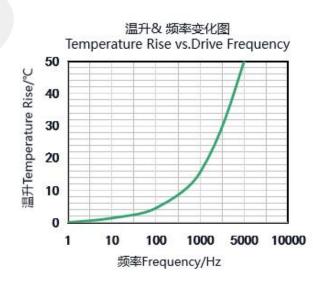






### **Performance Curve**





These temperature rises were measured after applying a sine-wave drive voltage ranging from 0 to 150V at the specified frequency for 10 minutes.

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## **Matters Needing Attention**

#### 1. Use of strain gauge

Electrical connection of strain sensor: excitation voltage is up to 4.5Vrms. The output voltage of the full bridge circuit can be used as a feedback signal by the controller to provide linear operation of the piezoelectric stack.

#### 2. Storage Conditions & Precautions:

Temperature: <50 °C, Humidity: <40%Rh. Avoid impact and compression. Store in vacuum-sealed bags for long-term preservation. When not in use, connect to a resistive discharge ( $\geq 100 \text{k}\Omega$ ) or short-circuit (for low-capacitance ceramics).

#### 3. Operating Conditions & Precautions:

Temperature: Maximum operating temperature ≤130°C (preferably <60°C). Add heat dissipation measures if temperature exceeds 80°C.

Humidity: <50%Rh. In high-humidity environments, preheat at low voltage before use to avoid creepage discharge.

Dust Avoidance: Dust adhesion on ceramic surfaces may reduce insulation resistance.

Clearance: Maintain a gap >1.6mm between ceramics and other conductors.

Safety: Do not immerse piezoelectric stacks in organic solvents or expose to flammable gases/liquids.

#### 4. Assembly Precautions:

Polarity: Red wire = positive (+), black wire = negative (-). Reverse polarity may cause mechanical failure.

Handling: Handle with care to avoid impact. Wear gloves to prevent oil contamination.

Fit Tolerance: Assemble with clearance fit first, then tighten. Avoid interference fit to prevent ceramic compression.

Electrostatic Protection: Maintain >1.6mm gap between ceramics and metal parts to avoid static discharge.

Adhesive Bonding: Ensure flat bonding surfaces and remove excess glue to minimize contamination.

Soldering: Limit contact time under high temperature to <1 second to protect ceramics and coatings.

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High-Temperature Assembly: Control temperature <120 $^{\circ}$ C to prevent depolarization, adhesive failure, or coating damage.

#### 5.Preload Instructions:

Load Application: Apply external load to the center of the stack or distribute uniformly on the mounting surface. Ensure contact surfaces are flat and smooth.

Force Direction: Piezoelectric stacks can only withstand axial forces. Shear or torsional forces may cause mechanical failure.

Preload Force: Preload should not exceed 40% of maximum blocking force, and its direction must align with the motion axis to minimize shear stress.

